Harvatek Surface Mount PLCC LEDs Data Sheet T1691NG--20C000312E0118

7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	*********				
Specifications are subject notice. Proprietary data, d	05/19/2022	Version 1.3	Page 1/14		

DISCLAIMER	3
LIFE SUPPORT POLICY	3
PRODUCT SPECIFICATIONS	1
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION	1
LABEL SPECIFICATIONS	5
SPECIFICATIONS RANGE	5
PRODUCT FEATURES	7
ELECTRO-OPTICAL CHARACTERISTICS	
Absolute Maximum Ratings	
PRECAUTION FOR USE)
PACKAGING10)
TAPE DIMENSION 10 REEL DIMENSION 17 PACKING 17 DRY PACK 17 BAKING 17 PRECAUTIONS 17	1 1 2 2
REFLOW SOLDERING	3
REWORKING	3 4

7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	***************************************				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 2/14	

DISCLAIMER

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	***************************************				
Specifications are subject notice. Proprietary data, dr	05/19/2022	Version 1.3	Page 3/14		

Product Specifications

Specification	Material	Quantity
NG:900 - 2250.0 mcd		
@20mA/ T _s = 25°C ;Tolerance: <u>+</u> 10%		
NG:515.0 - 540.0 nm		
@20mA/ T _S = 25 $^\circ$ C ;Tolerance: <u>+</u> 0.5nm		
NG:2.7-3.7 V		
@20mA/ Ts= 25 $^\circ\!\!\mathrm{C}$;Tolerance: <u>+</u> 0.05V		
< 10 µA @ V _R = 5 V		
Clear	Silicon	
EIA 481-1A specs	Conductive black tape	
EIA 481-1A specs	Conductive black	
HT standard	Paper	
250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
HT standard	Paper	Non-specified
	NG:900 - 2250.0 mcd @ 20mA/ T_s = 25°C;Tolerance: \pm 10% NG:515.0 - 540.0 nm @ 20mA/ T_s = 25°C;Tolerance: \pm 0.5nm NG:2.7-3.7 V @ 20mA/ T_s = 25°C;Tolerance: \pm 0.05V < 10 μ A @ V _R = 5 V Clear EIA 481-1A specs EIA 481-1A specs HT standard 250x230mm	NG:900 - 2250.0 mcd $@20mA/T_s = 25^{\circ}C$;Tolerance: $\pm 10\%$ NG:515.0 - 540.0 nm $@20mA/T_s = 25^{\circ}C$;Tolerance: $\pm 0.5nm$ WG:2.7-3.7 V $@20mA/T_s = 25^{\circ}C$;Tolerance: $\pm 0.05V$ < 10 $\mu A @ V_R = 5 V$ Clear Silicon EIA 481-1A specs Conductive black tape EIA 481-1A specs Conductive black tape HT standard Paper 250x230mm Aluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin

combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts

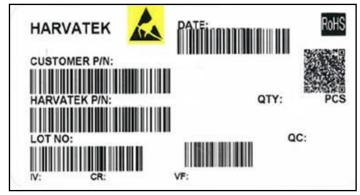
built with AIGaInP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must

be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	*********				
Specifications are subjec notice. Proprietary data, dr	05/19/2022	Version 1.3	Page 4/14		

Label Specifications



Harvatek P/N:

T 169 1 NG-- 20C- 0003 12

Product	Package	Dice Qty	Color	Current	Series Number	Taping
LF	3.5(L) x 2.8(W) x 1.9(H) mm	1:Single	NG:Green	20mA	X001~XZZZ	1.Taping style 2. Qty

Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Cod	e 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	е
Internal Tra	acing Code	2020-L 2021-M 2022-P 2023-Q 2026-T 2027-V 2030-Y 2031-Z 	1:Jan. 2:Feb. A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C 26:Z 27:7 28:8 29:9 30:3 31:4	01-	-ZZ		000~ZZZ	

Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	***************************************				
Specifications are subjec notice. Proprietary data, dr	05/19/2022	Version 1.3	Page 5/14		

Specifications Range

Luminous Intensity (Iv) Bin:

-		
Color	Bin Code	Spec. Range
	Y2	1000.0-1125.0 mcd
	Z	1125.0-1440.0 mcd
NG	AA	1440.0-1800.0 mcd
	AB	1800.0-2250.0 mcd

Note: It maintains a tolerance of ±10% on Luminous Intensity

Wavelength Bin:

Color	Bin Code	Spec. Range
	Α	515.0-520.0 nm
	В	520.0-525.0 nm
NG	С	525.0-530.0 nm
	D	530.0-535.0 nm
	E	535.0-540.0 nm

Note: It maintains a tolerance of ±0.5nm on Wavelength Bin

Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
	G8	2.7-2.9
	H7	2.9-3.1
NG	H8	3.1-3.3
	J7	3.3-3.5
	J8	3.5-3.7

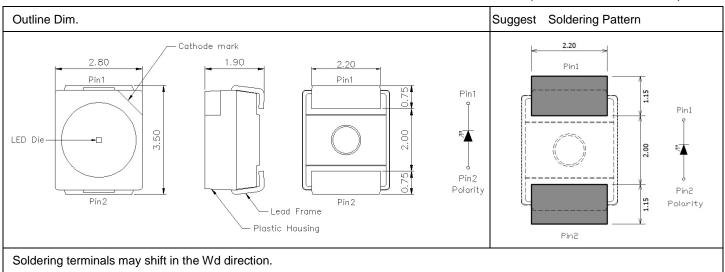
Note: It maintains a tolerance of ±0.05V on forward voltage measurements

Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	*****	******			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 6/14	

Product Features

Electro-Optical Characteristics

(T _{Soldering} , 25 °C)							oldering , 25 °C)		
				(V)	Wa	velength λ	(nm)	l _∨ (mcd)	Viewing
Series	Emitting Color	Material	typ	max	λ_D	λ _P	∆λ	Typical	Angle $2\theta \frac{1}{2}$
T1691NG	Green	InGaN	3.2	3.7	525	517	25	1440	120



Absolute Maximum Ratings

(T_{Soldering} 25 ℃)

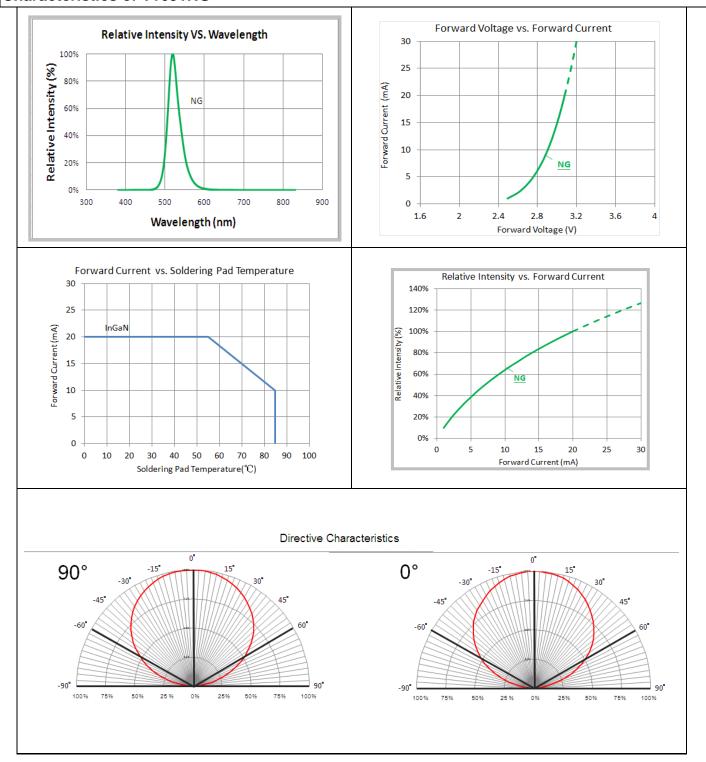
Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	Т _{ОР} (°С)	T _{ST} (℃)
Color	Power	Forward	Pulse Forward	Operating	Storage
	Dissipation	Current	Current	Temperature	Temperature
NG	74	20	80	-40~+85	-40~+100

*Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	*****	*****			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 7/14	

(Unit:mm Tolerance: +/-0.25)

Characteristics of T1691NG



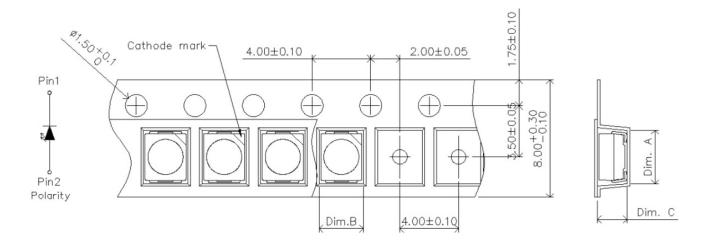
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	******				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 8/14	

Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 72 hrs after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

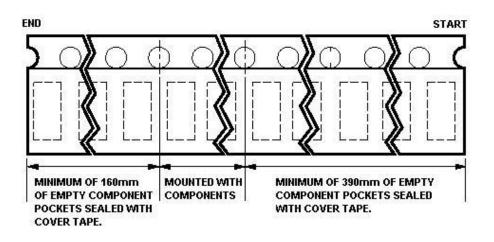
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	********				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 9/14	

Packaging Tape Dimension



Dim. A	Dim. B	Dim. C	Qty/Reel
3.73±0.10	2.95±0.10	2.12±0.10	2K

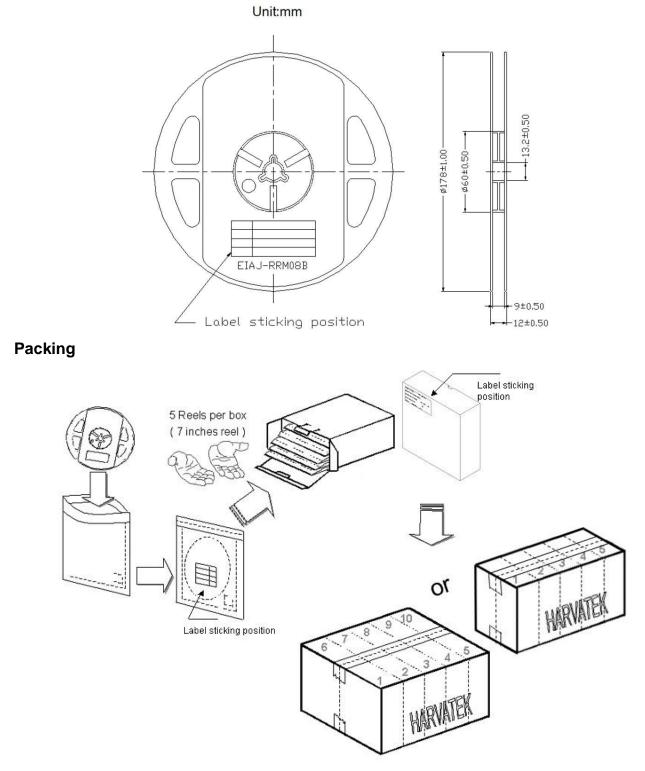
Unit: mm



Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	*******				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 10/14	

Reel Dimension

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5 or 10 boxes per carton is available depending on shipment quantity.

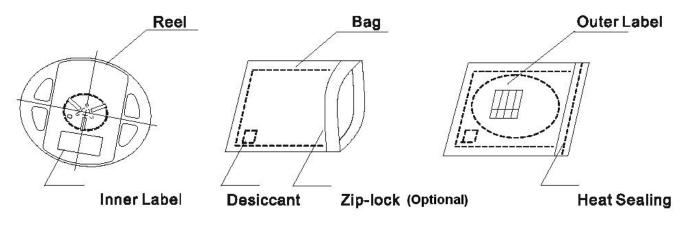
7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	********				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 11/14	

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 72 hrs. The conditions are as followings:

- 1. $60\pm3^{\circ}C\times(12\sim24hrs)$ and <5% RH, taped reel type.
- 2. 100±3°C×(45min~1hr), bulk type.
- 3. 130±3°C ×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlGaInP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

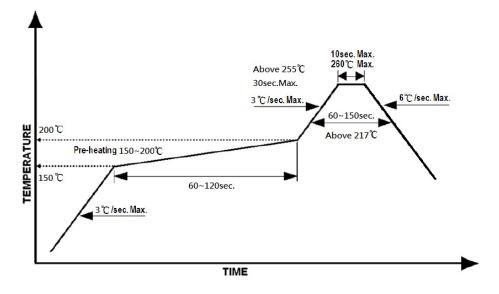
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	***************************************				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 12/14	

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 217° C ,60~150 sec.
- 2. Peak temp.:260 ^OCMax.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 ^OC max, <3min

7					
Official Product	HT Part No.T1691NG20C000312E0118				
Tentative Product	*****	*****			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 13/14	

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
1.0	New Format	10/29/2019	-
1.1	Modify The Luminous Intensity (Iv) Bin	07/25/2018	P6
1.2	Renew the Format	12/07/2018	-
1.3	Add Customer Product Code	05/19/2022	P5

Official Product	HT Part No.T1691NG20C000312E0118			
Tentative Product	*****	****		
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		05/19/2022	Version 1.3	Page 14/14